

**Product Summary**

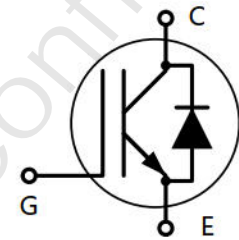
Part #	$V_{CE}$	$I_C @ T_C = 100^\circ\text{C}$	$V_{CEsat}, T_{vj} = 25^\circ\text{C}$
DP30N65PBDQI1	650V	30A	1.7V

**Features**

- Uses advanced FS IGBT technology
- Excellent conduction and switching loss
- Excellent stability and uniformity
- Fast and soft antiparallel diode

**Applications**

- Induction converters
- Uninterruptible power supplies
- Home Appliances


**Package Marking and Ordering Information**

Part #	Marking	Package	Packing
DP30N65PBDQI1	30N65PBDQI	TO-220	Tube


**Absolute Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-Emitter voltage	$V_{CE}$	650	V
Continuous collector current	$I_C$	60 30	A
$T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$			
Pulsed collector current ( $T_C = 25^\circ\text{C}$ , $t_p$ limited by $T_{jmax}$ )	$I_{D\ pulse}$	120	A
Turn off safe operating area $V_{CE} \leq 650\text{V}$ , $T_{vj} \leq 175^\circ\text{C}$	-	120	A
Diode forward current	$I_F$	60 30	A
$T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$			
Diode pulsed current ( $T_C = 25^\circ\text{C}$ , $t_p$ limited by $T_{jmax}$ )	$I_{F\ pulse}$	120	A
Gate-emitter voltage	$V_{GE}$	$\pm 30$	V
Power dissipation ( $T_C = 25^\circ\text{C}$ )	$P_{tot}$	167	W
Operating junction temperature	$T_j, T_{stg}$	-40...+175	$^\circ\text{C}$
Storage temperature	$T_j, T_{stg}$	-55...+150	$^\circ\text{C}$

**Thermal Resistance**

Parameter	Symbol	Max	Unit
IGBT thermal resistance, junction case. Max	$R_{thJC}$	0.9	°C/W
Diode thermal resistance, junction case. Max	$R_{thJC}$	1.9	
Thermal resistance, junction – ambient. Max	$R_{thJA}$	65	

**Electrical Characteristic (at  $T_j = 25^\circ\text{C}$ , unless otherwise specified)**

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		

**Static Characteristic**

Collector-emitter breakdown voltage	$V_{(BR)CES}$	650	-	-	V	$V_{GE}=0V, I_C=250\mu A$
Collector-emitter saturation voltage	$V_{CEsat}$	-	1.7	2.2	V	$V_{GE} = 15V, I_C = 30A$ $T_{vj}=25^\circ\text{C}$
		-	2.1	-		$T_{vj}=175^\circ\text{C}$
Diode forward voltage	$V_F$	-	1.6	2.2	V	$V_{GE} = 0V, I_F = 30A$ $T_{vj}=25^\circ\text{C}$
		-	1.3	-		$T_{vj}=175^\circ\text{C}$
Gate-emitter threshold voltage	$V_{GE(th)}$	5	5.6	6.2	V	$V_{GE} = V_{CE}, I_C = 1mA$
Zero gate voltage collector current	$I_{CES}$	-	-	1	$\mu A$	$V_{CE}=650V, V_{GS}=0V$ $T_{vj}=25^\circ\text{C}$
		-	100	-		$T_{vj}=150^\circ\text{C}$
Gate-emitter leakage current	$I_{GES}$	-	-	100	nA	$V_{CE} = 0V, V_{GE} = \pm 30V$
Transconductance	$g_{fs}$	-	17	-	S	$V_{CE} = 20V, I_{CE} = 10A$

**Dynamic Characteristic**

Input Capacitance	$C_{ies}$	-	1955	-	pF	$V_{CE} = 30V, V_{GE} = 0V,$ $f = 100KHz$
Output Capacitance	$C_{oes}$	-	108	-		
Reverse Transfer Capacitance	$C_{res}$	-	23	-		
Gate Total Charge	$Q_g$	-	105	-	nC	$V_{CC} = 520V, I_C = 30A,$ $V_{GE} = 15V$
Gate-Source charge	$Q_{ge}$	-	8	-		
Gate-Drain charge	$Q_{gc}$	-	64	-		
Turn-on delay time	$t_{d(on)}$	-	32	-	ns	$T_{vj} = 25^\circ C,$ $V_{CC} = 400V, I_C = 30A,$ $V_{GE} = 15.0V,$ $R_G = 10.0\Omega$
Rise time	$t_r$	-	38	-		
Turn-off delay time	$t_{d(off)}$	-	158	-		
Fall time	$t_f$	-	32	-		
Turn-on energy	$E_{on}$	-	1.6	-	mJ	
Turn-off energy	$E_{off}$	-	0.6	-		

**Diode Characteristic**

Parameter	Symbol	Value			Unit	Test Condition
		min.	typ.	max.		
Diode peak reverse recovery current	$I_{rrm}$	-	16	-	A	$T_{vj} = 25^\circ C,$ $V_R = 400V,$ $I_F = 30.0A,$ $diF/dt = -550A/\mu s$
Body Diode Reverse Recovery Time	$t_{rr}$	-	102	-	ns	
Body Diode Reverse Recovery Charge	$Q_{rr}$	-	851	-	nC	

Typical Performance Characteristics

Fig 1. Typical output characteristic ( $T_{vj}=25^{\circ}\text{C}$ )

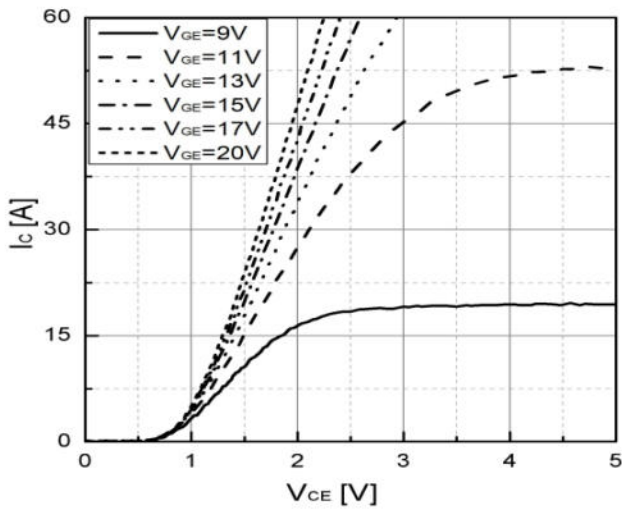


Fig 2. Typical output characteristic ( $T_{vj}=175^{\circ}\text{C}$ )

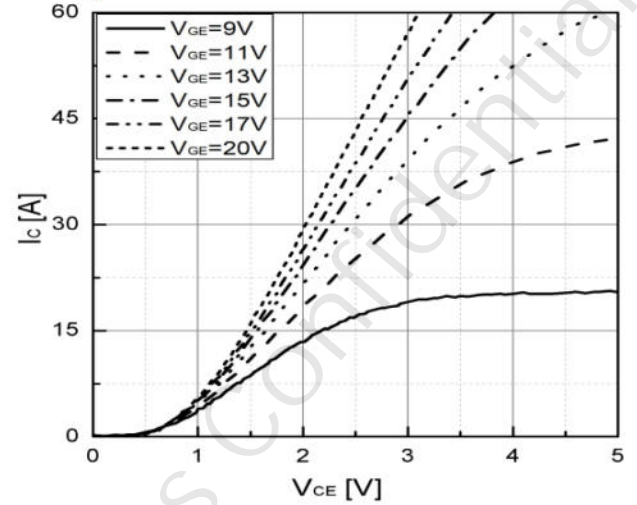


Fig 3. Power dissipation as a function of  $T_c$

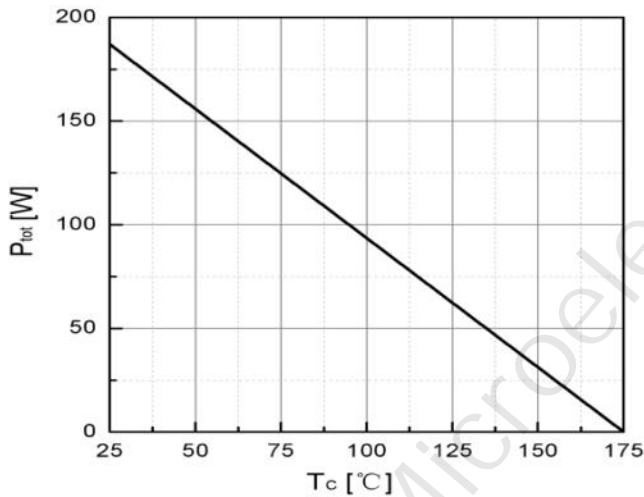


Fig 4. Typical Gate charge

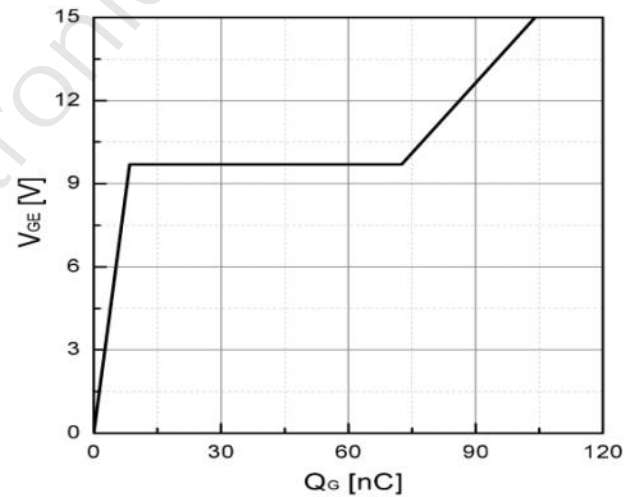


Fig 5. Typical  $V_{GE(th)}$  as a function of  $T_{vj}$  ( $I_C=1\text{mA}$ )

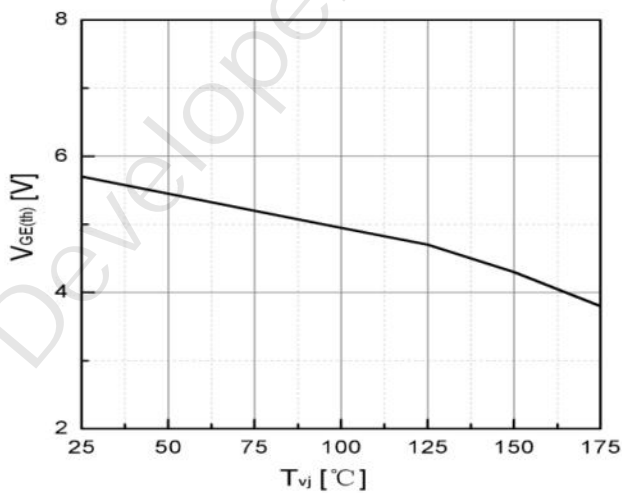


Fig 6. Typical  $V_F$  as a function of  $T_{vj}$

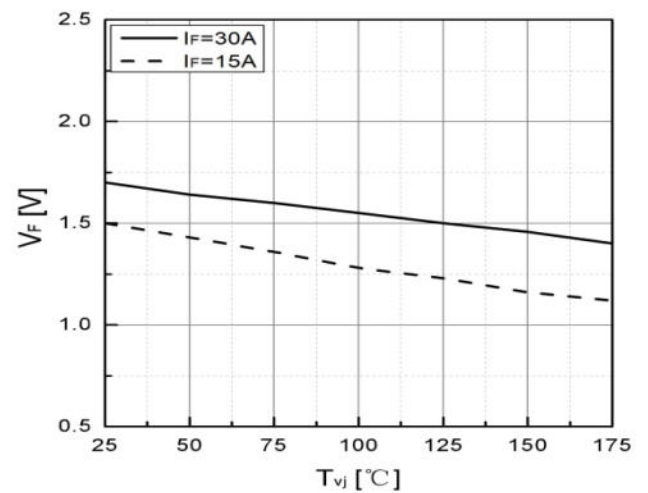


Fig 7. Typical  $V_{CEsat}$  as a function of  $T_{vj}$

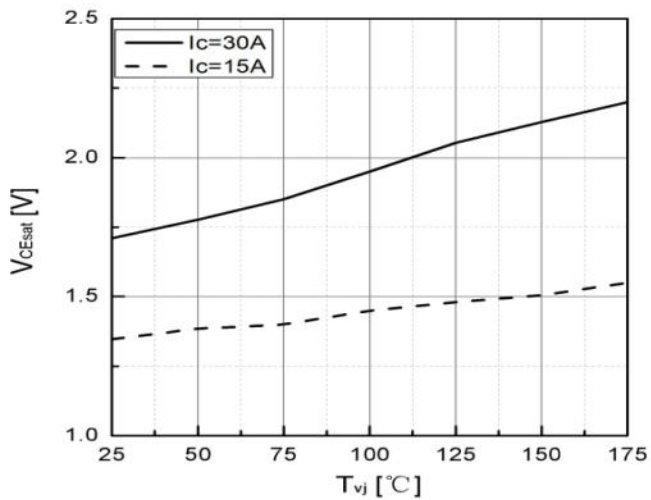


Fig 8. Typical  $I_F$  as a function of  $V_F$

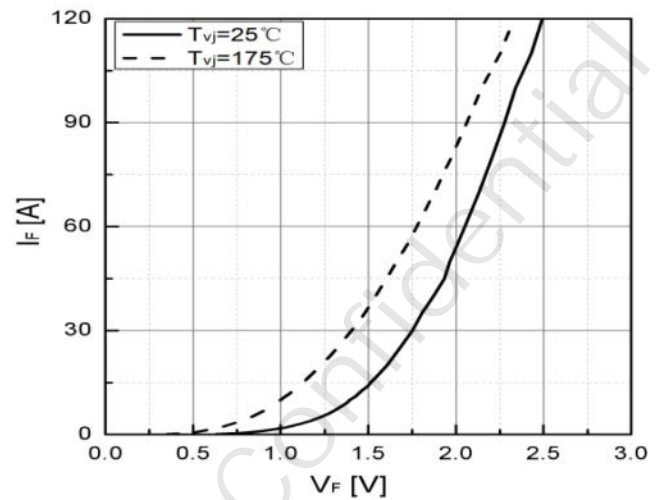


Fig 9. Typical switching time as a function of  $I_C$

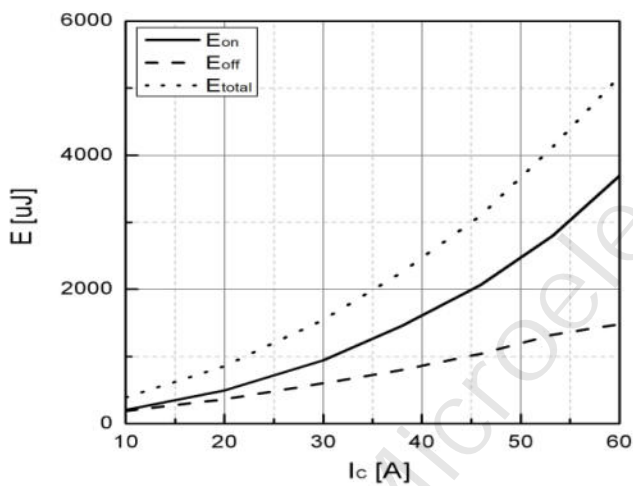


Fig 10. Typical switching times as a function of  $R_G$

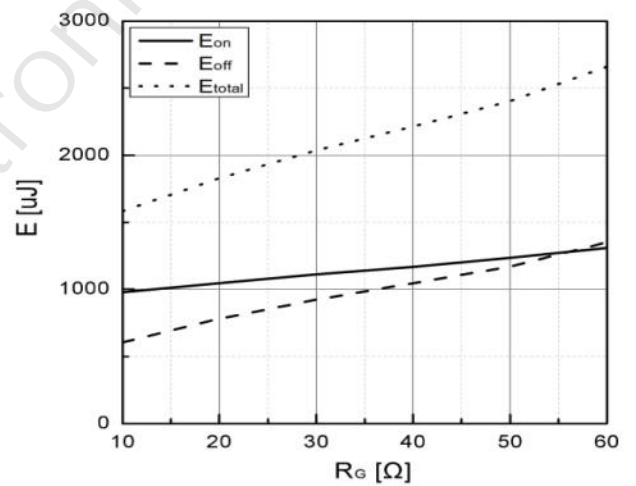


Fig 11. Typical switching energy losses as a function of  $I_C$

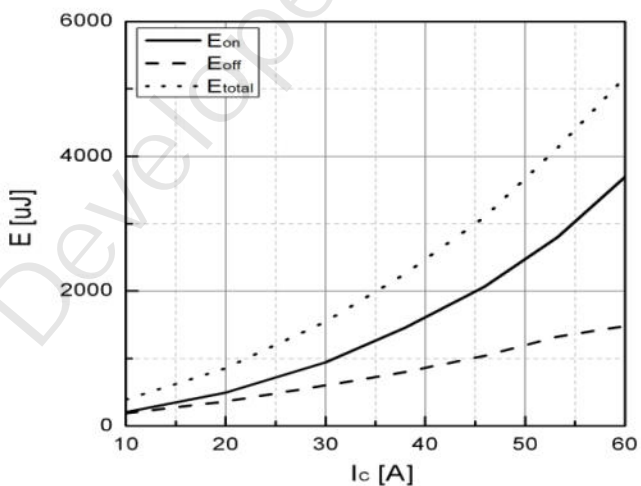


Fig 12. Typical switching energy losses as a function of  $R_G$

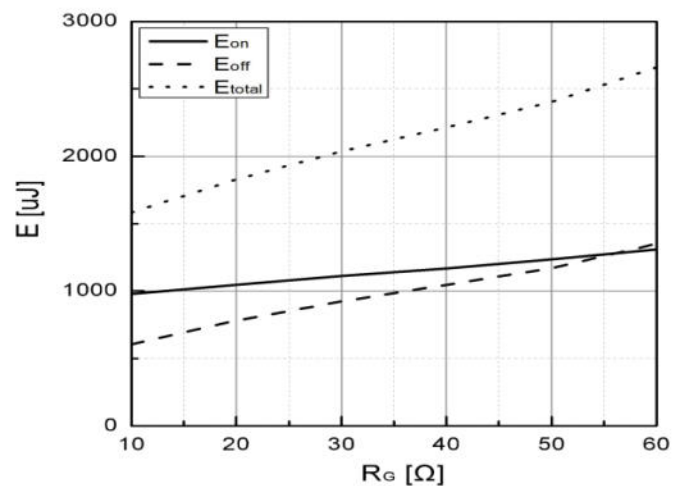
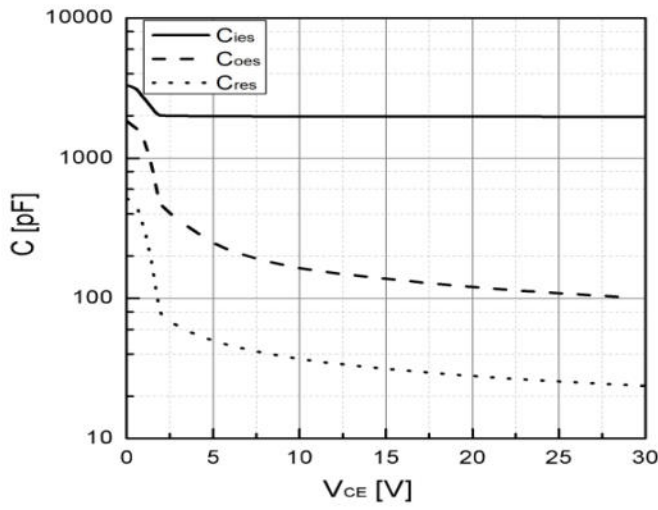
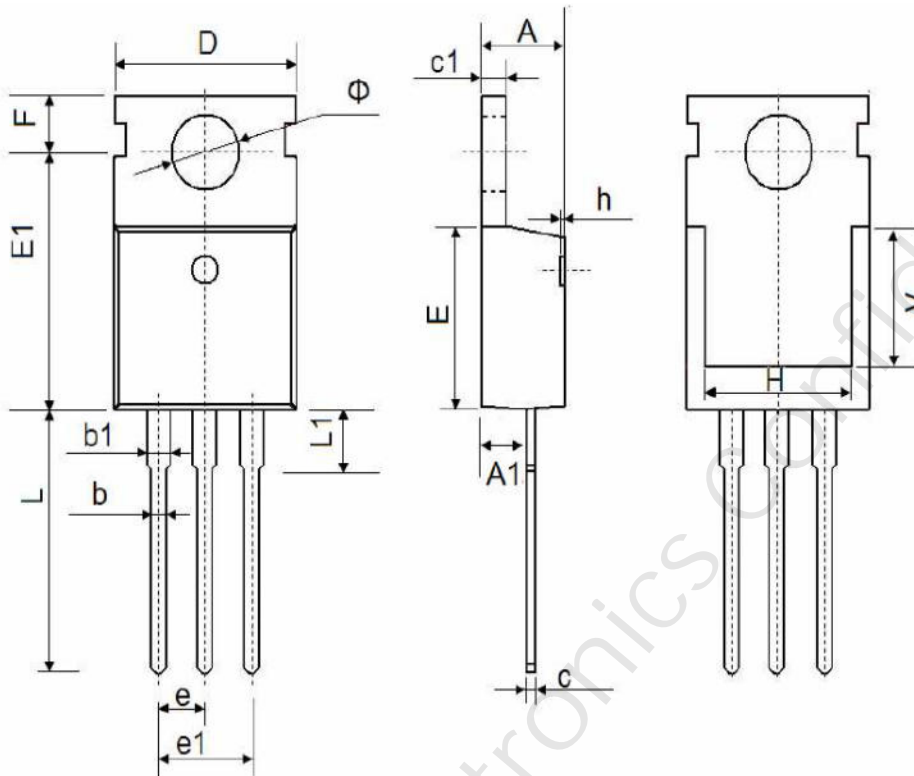


Fig 13. Typical capacitance as a function of  $V_{CE}$   
( $f=1\text{MHz}$ ,  $V_{GE}=0\text{V}$ )

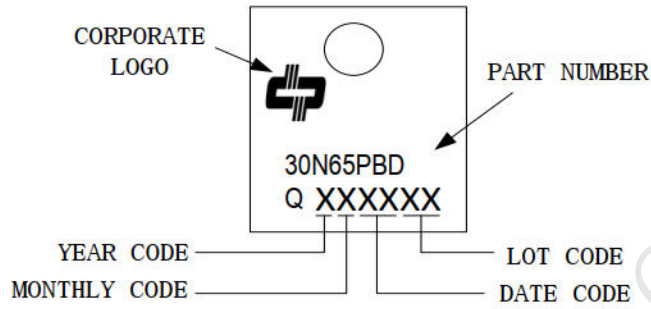


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**Package Outline: TO-220-3L**


Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.30	4.70	0.169	0.185
A1	2.25	2.55	0.089	0.100
b	0.71	0.91	0.028	0.036
b1	1.17	1.37	0.046	0.054
c	0.33	0.65	0.013	0.026
c1	1.20	1.40	0.047	0.055
D	9.91	10.25	0.390	0.404
E	8.95	9.75	0.352	0.384
E1	12.65	12.95	0.498	0.510
e	2.54 BSC.		0.100 BSC.	
e1	4.98	5.18	0.196	0.204
F	2.65	2.95	0.104	0.116
H	7.90	8.10	0.311	0.319
h	0.00	0.30	0.000	0.012
L	12.90	13.40	0.508	0.528
L1	2.85	3.25	0.112	0.128
V	7.500 Ref.		0.295 Ref.	
Φ	3.400	3.800	0.134	0.150

**Part Marking Information**



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## Revision History

Revision	Major changes
1.0	Release for initial version

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